

MOSFET – Power, for 1-Cell Lithium-ion Battery Protection, Dual N-Channel

12 V, 18 A, 5.9 m Ω

EFC6602R

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

Features

- 2.5 V Drive
- 2 kV ESD HBM
- Common–Drain Type
- ESD Diode-Protected Gate
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Typical Applications

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

Specifications

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Parameter	Symbol	Value	Unit
Source-to-Source Voltage	V _{SSS}	12	V
Gate-to-Source Voltage	V_{GSS}	±12	V
Source Current (DC)	ls C	18	JA
Source Current (Pulse) PW ≤ 10 μs, duty cycle ≤ 1%	SISP	60	Α
Total Dissipation (Note 1)	P _T	2.0	W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	– 55 to +150	°C

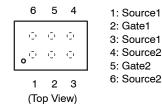
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient (Note 1)	$R_{\theta JA}$	62.5	°C/W

1. Surface mounted on ceramic substrate (5000 mm² x 0.8 mm)

PIN ASSIGNMENT



V _{SSS}	R _{SS(on)} Max	I _S Max
12 V	5.9 mΩ @ 4.5 V	18 A
	$6.3~\text{m}\Omega$ @ $4.0~\text{V}$	
	$6.5~\mathrm{m}\Omega$ @ $3.8~\mathrm{V}$	
	8.2 mΩ @ 3.1 V	
	11 mΩ @ 2.5 V	



WLCSP6 1.81x2.70 / EFCP2718-6CE-020 CASE 567HS

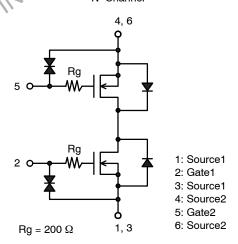
MARKING DIAGRAM



MB = Specific Device Code
Y = Year of Production
M = Assembly Operation Month
ZZ = Assembly Lot Number

ELECTRICAL CONNECTION

N-Channel



ORDERING INFORMATION

Device	Package	Shipping
EFC6602R-TR	WLCSP6 (Pb-Free and Halogen Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Parameter	Symbol	Conditions		Min	Тур	Max	Unit
Source-to-Source Breakdown Voltage	V _{(BR)SSS}	I _S = 1 mA, V _{GS} = 0 V	Test Circuit 1	12	-	-	V
Zero-Gate Voltage Source Current	I _{SSS}	V _{SS} = 10 V, V _{GS} = 0 V	Test Circuit 1	-	-	1	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = ±8 V, V _{SS} = 0 V	Test Circuit 2	-	-	±1	μΑ
Gate Threshold Voltage	V _{GS} (th)	V _{SS} = 6 V, I _S = 1 mA	Test Circuit 3	0.5	-	1.3	V
Forward Transconductance	9 _{FS}	V _{SS} = 6 V, I _S = 3 A	Test Circuit 4	-	13	_	S
Static Source-to-Source On-State	R _{SS} (on)	I _S = 3 A, V _{GS} = 4.5 V	Test Circuit 5	3.1	4.5	5.9	mΩ
Resistance		I _S = 3 A, V _{GS} = 4.0 V	Test Circuit 5	3.3	4.8	6.3	mΩ
		I _S = 3 A, V _{GS} = 3.8 V	Test Circuit 5	3.5	5.0	6.5	mΩ
		I _S = 3 A, V _{GS} = 3.1 V	Test Circuit 5	4.0	5.8	8.2	mΩ
		I _S = 3 A, V _{GS} = 2.5 V	Test Circuit 5	5.2	7.5	11	mΩ
Turn-ON Delay Time	t _d (on)	V _{SS} = 6 V, V _{GS} = 4.5 V,	Test Circuit 6		530	17.	ns
Rise Time	t _r	I _S = 3 A		-	2100	(Q)	ns
Turn-OFF Delay Time	t _d (off)			1	6200	-	ns
Fall Time	t _f			N _z .	5500	-	ns
Total Gate Charge	Qg	V _{SS} = 6 V, V _{GS} = 4.5 V, I _S = 18 A	Test Circuit 7	JE.	55	-	nC
Forward Source-to-Source Voltage	V _{F(S-S)}	I _S = 3 A, V _{GS} = 0 V	Test Circuit 8	W)	0.76	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test circuits are example of measuring FET1 side.

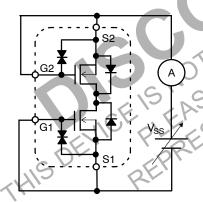
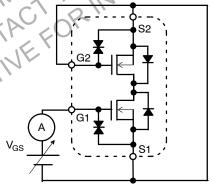


Figure 1. Test Circuit 1 - V_{(BR)SSS} / I_{SSS}



When FET1 is measured, Gate and Source of FET2 are short-circuited.

Figure 2. Test Circuit 2 - I_{GSS}

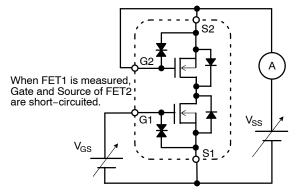


Figure 3. Test Circuit 3 - V_{GS}(th)

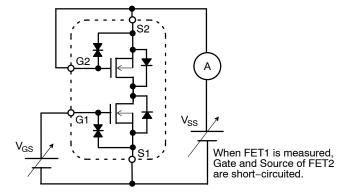


Figure 4. Test Circuit 4 - g_{FS}

TEST CIRCUITS (continued)

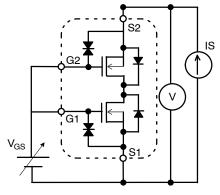


Figure 5. Test Circuit 5 - R_{SS}(on)

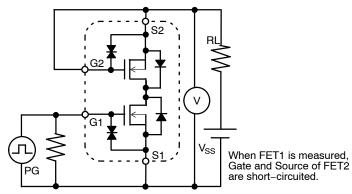
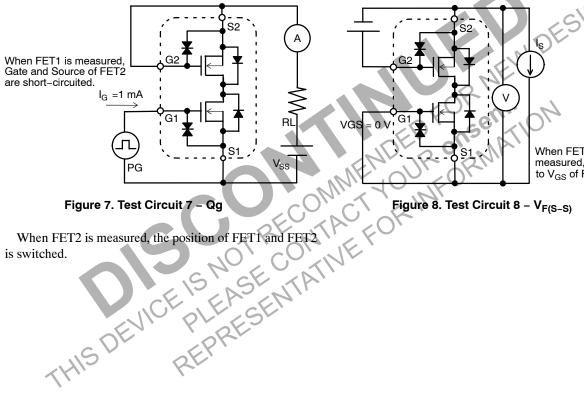
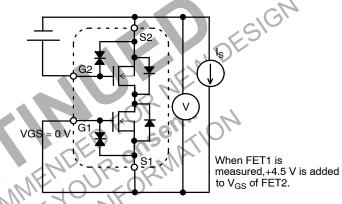


Figure 6. Test Circuit 6 – $t_d(on)$, t_r , $t_d(off)$, t_f





is switched.

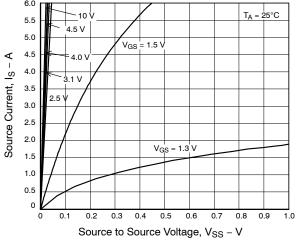


Figure 9. $I_D - V_{SS}$

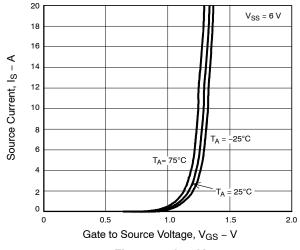


Figure 10. I_S - V_{GS}

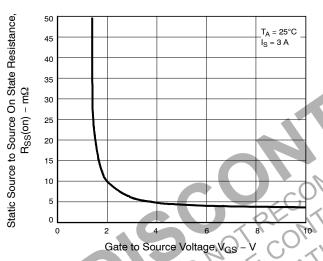


Figure 11. R_{SS}(on) – V_{GS}

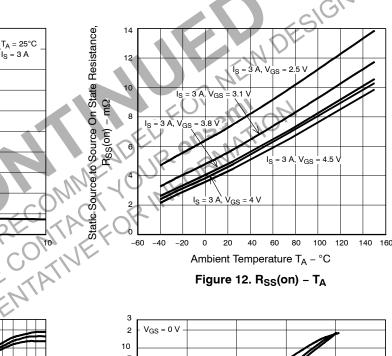
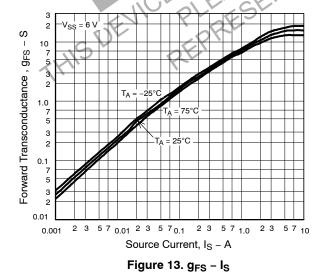
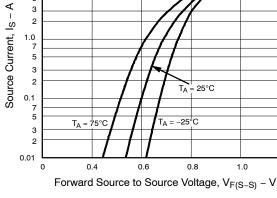


Figure 12. R_{SS}(on) - T_A





V_{GS} = 0 V

10

1.0 7

Figure 14. I_S - V_{F(S-S)}

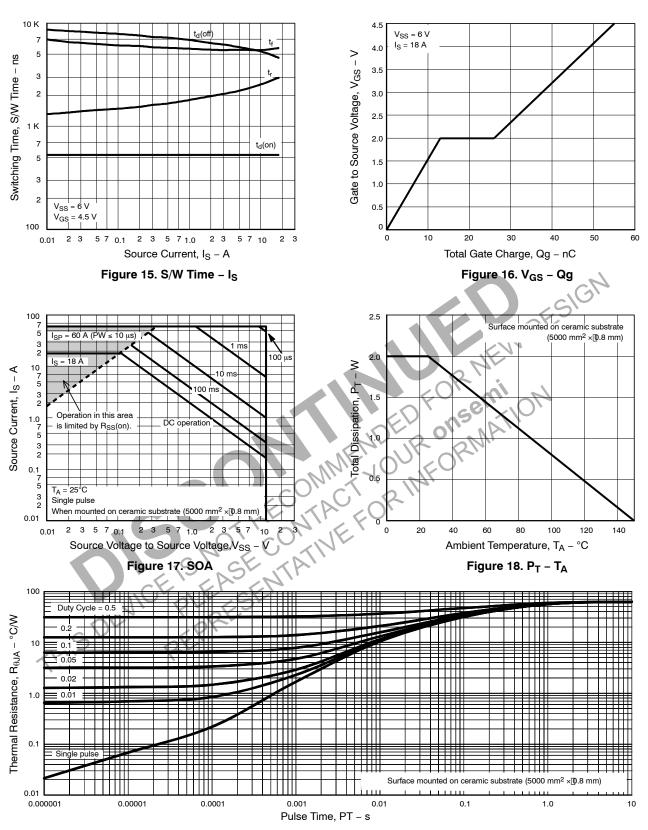
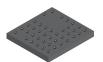


Figure 19. $R_{\theta JA}$ – Pulse Time

Note on usage: Since the EFC6602R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

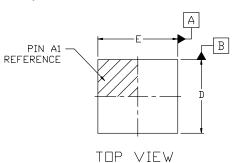






WLCSP40 2.301x2.499x0.369 CASE 567HU **ISSUE 0**

DATE 29 APR 2022



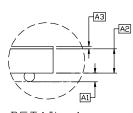
DETAIL A-

SIDE VIEW

0.08 C

 \triangle 0.03 C

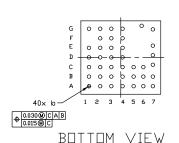
	MILLIMETERS					
DIM	MIN.	N□M.	MAX.			
Α	0.333	0.369	0.405			
A1	0.070	0.090	0.110			
A2		0.254 REF				
A3	0.022	0.025	0.028			
b	0.096	0.111	0.126			
D	2.276	2.301	2.326			
E	2.474	2.499	2.524			

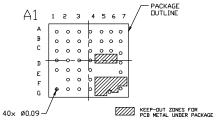


DETAIL SCALE 1:3

SEATING PLANE

C





RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS DIMENSION 6 IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER
- PARALLEL TO DATUM C.
 COPLANARITY APPLIES TO THE
 SPHERICAL CROWNS OF THE SOLDER
- BALLS.
 DATUM C, THE SEATING PLANE, IS
 DEFINED BY THE SPHERICAL CROWNS OF
 THE SOLDER BALLS.

BALL POSITION TABLE						
BALL	X	Υ		BALL	X	Υ
A1	-1.00	-0.90		D1	-1.00	0.00
A2	-0.65	-0.90		D2	-0.65	0.00
A3	-0.30	-0.90		D3	-0.30	0.00
A4	0.05	-0.90		D4	0.05	0.00
A5	0.40	-0.90		D7	1.00	0.07
A6	0.70	-0.90		E1	-1.00	0.30
A7	1.00	-0.90		E2	-0.65	0.30
B1	-1.00	-0.60		E3	-0.30	0.30
B2	-0.65	-0.60		E4	0.05	0.30
В3	-0.30	-0.60		E7	1.00	0.37
B4	0.05	-0.60		F2	-0.65	0.60
B5	0.40	-0.60		F3	-0.30	0.60
В6	0.70	-0.60		F4	0.05	0.60
B7	1.00	-0.60		G1	-1.00	0.90
C1	-1.00	-0.30		G2	-0.65	0.90
C2	-0.65	-0.30		G3	-0.30	0.90
С3	-0.30	-0.30		G4	0.05	0.90
C4	0.05	-0.30		G6	0.65	0.99
C5	0.40	-0.30		G7	1.00	0.88
C6	0.70	-0.30				
C7	1.00	-0.23				

MOUNTING PAD POSITION TABLE						
BALL	×	Y	BALL	X	Υ	
A1	-1.00	0.90	D1	-1.00	0.00	
A2	-0.65	0.90	D2	-0.65	0.00	
A3	-0.30	0.90	D3	-0.30	0.00	
Α4	0.05	0.90	D4	0.05	0.00	
A5	0.40	0.90	D7	1.00	-0.07	
A6	0.70	0.90	E1	-1.00	-0.30	
Α7	1.00	0.90	E2	-0.65	-0.30	
B1	-1.00	0.60	E3	-0.30	-0.30	
B2	-0.65	0.60	E4	0.05	-0.30	
ВЗ	-0.30	0.60	E7	1.00	-0.37	
B4	0.05	0.60	F2	-0.65	-0.60	
B5	0.40	0.60	F3	-0.30	-0.60	
В6	0.70	0.60	F4	0.05	-0.60	
В7	1.00	0.60	G1	-1.00	-0.90	
C1	-1.00	0.30	G2	-0.65	-0.90	
C2	-0.65	0.30	G3	-0.30	-0.90	
С3	-0.30	0.30	G4	0.05	-0.90	
C4	0.05	0.30	G6	0.65	-0.99	
C5	0.40	0.30	G7	1.00	-0.88	
C6	0.70	0.30				
C7	1.00	0.23				

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